

September 2008

# FDN5632N\_F085

# N-Channel Logic Level PowerTrench $^{\circledR}$ MOSFET 60V, 1.6A, 98m $\Omega$

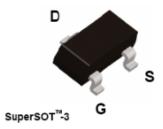
### **Features**

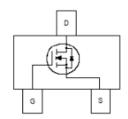
- $\blacksquare$  R<sub>DS(on)</sub> = 98m $\Omega$  at V<sub>GS</sub> = 4.5V, I<sub>D</sub> = 1.6A
- $R_{DS(on)} = 82m\Omega$  at  $V_{GS} = 10V$ ,  $I_D = 1.7A$
- Typ  $Q_{g(TOT)} = 9.2nC$  at  $V_{GS} = 10V$
- Low Miller Charge
- Qualified to AEC Q101
- RoHS Compliant

## **Applications**

- DC/DC converter
- Motor Drives







Units

# **MOSFET Maximum Ratings** $T_A = 25$ °C unless otherwise noted

Symbol	Parameter	Ratings	Units
V <sub>DSS</sub>	Drain to Source Voltage	60	V
$V_{GS}$			V
	Drain Current Continuous (V <sub>GS</sub> = 10V)	1.7	^
ID	Pulsed	10	A
$P_{D}$	Power Dissipation	1.1	W
$T_J$ , $T_{STG}$	Operating and Storage Temperature	-55 to +150	°C

### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance Junction to Case	75	°C/W
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-252, 1in <sup>2</sup> copper pad area	111	°C/W

# **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
5632	FDN5632N_F085	SSOT3	7"	8mm	3000 units

# **Electrical Characteristics** $T_A = 25$ °C unless otherwise noted

**Parameter** 

Off Cha	Off Characteristics						
B <sub>VDSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0$	V	60	-	-	V
1	Zero Gate Voltage Drain Current	$V_{DS} = 48V$ ,		•	-	1	μА
IDSS	Zelo Gale Vollage Dialii Current	$V_{GS} = 0V$	$T_A = 125^{\circ}C$	•	-	250	μΑ
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

**Test Conditions** 

Min

Тур

Max

### **On Characteristics**

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1	2.0	3	V
		$I_D = 1.7A, V_{GS} = 10V$	-	57	82	
		$I_D = 1.6A, V_{GS} = 6V$	-	62	88	
r <sub>DS(on)</sub>	Drain to Source On Resistance	$I_D = 1.6A, V_{GS} = 4.5V$		70	98	mΩ
		$I_D = 1.7A, V_{GS} = 10V,$ $T_A = 150^{\circ}C$	-	107	135	

# **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	01/	-	475	-	pF
Coss	Output Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1MHz		-	60	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 11/11/12		-	30	-	pF
$R_G$	Gate Resistance	f = 1MHz		-	1.4	-	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	V <sub>GS</sub> = 0 to 10V	1/ 001/	-	9.2	12	nC
Q <sub>gs</sub>	Gate to Source Gate Charge		$V_{DD} = 20V$ $I_{D} = 1.7A$	-	1.5	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge		ID = 1.77	=	1.4	-	nC

Units

ns

ns

ns

Max

12.9

# **Electrical Characteristics** $T_A = 25^{\circ}C$ unless otherwise noted

**Parameter** 

Switc	Switching Characteristics					
t <sub>on</sub>	Turn-On Time		-	-	30	ns
t <sub>d(on)</sub>	Turn-On Delay Time		-	15	-	ns
t <sub>r</sub>	Rise Time	$V_{DD} = 30V, I_D = 1.0A$	-	1.7	-	ns
t	Turn Off Dolay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		5.2		nc

**Test Conditions** 

Min

Тур

5.2

1.3

# **Drain-Source Diode Characteristics**

Turn-Off Delay Time

Fall Time

Turn-Off Time

Symbol

t<sub>d(off)</sub>

V <sub>SD</sub>	Source to Drain Diode Voltage	I <sub>SD</sub> = 1.7A	-	0.8	1.25	V
	Source to Drain blode voltage	$I_{SD} = 0.85A$	-	0.8	1.0	
t <sub>rr</sub>	Reverse Recovery Time	- 1.70 dl /dt - 1004/up	-	16.0	21	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{SD} = 1.7A$ , $dI_{SD}/dt = 100A/\mu s$	-	7.9	10.3	nC

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/
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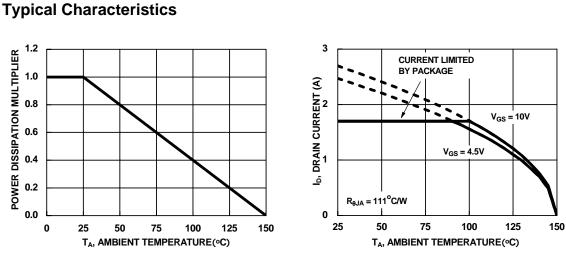


Figure 1. Normalized Power Dissipation vs Ambient Temperature

Figure 2. Maximum Continuous Drain Current vs
Ambient Temperature

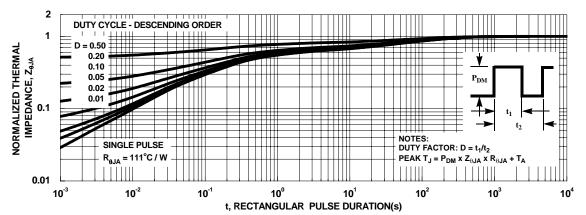


Figure 3. Normalized Maximum Transient Thermal Impedance

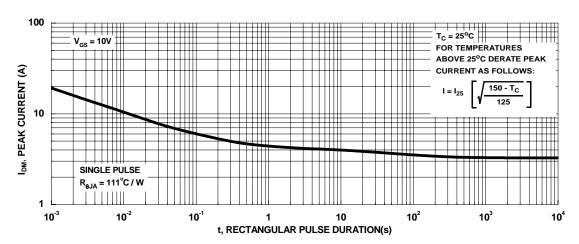


Figure 4. Peak Current Capability

# **Typical Characteristics**

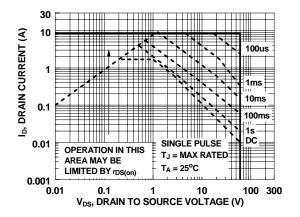


Figure 5. Forward Bias Safe Operating Area

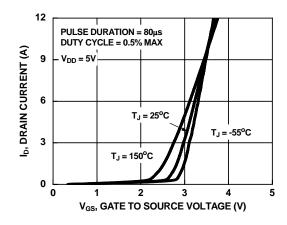


Figure 6. Transfer Characteristics

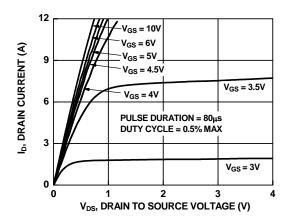


Figure 7. Saturation Characteristics

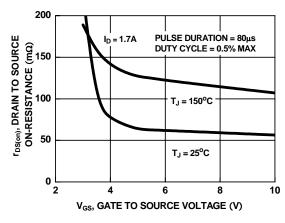


Figure 8. Drain to Source On-Resistance Variation vs Gate to Source Voltage

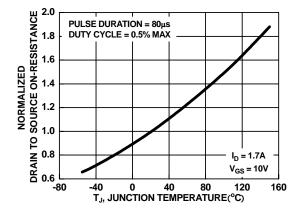


Figure 9. Normalized Drain to Source On Resistance vs Junction Temperature

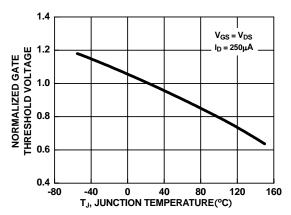


Figure 10. Normalized Gate Threshold Voltage vs Junction Temperature

# **Typical Characteristics**

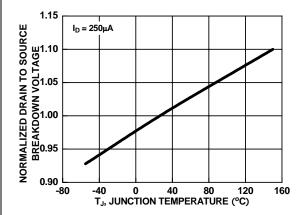


Figure 11. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

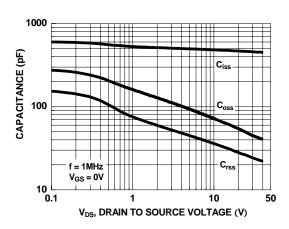


Figure 12. Capacitance vs Drain to Source Voltage

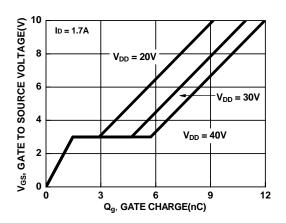


Figure 13. Gate Charge vs Gate to Source Voltage





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